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STL15DN4F5

Automotive-grade dual N-channel 40 V, 8 mΩ typ., 15 A STripFET™ F5 Power MOSFET in a PowerFLAT™ 5x6 DI

Datasheet - production data





Features

Order code	VDS	RDS(on) max.	ID
STL15DN4F5	40 V	9 mΩ	15 A

- Designed for automotive applications and AEC-Q101 qualified
- Extremely low R_{DS(on)}
- Very low gate charge
- Low gate drive power loss
- Wettable flank package

Applications

• Switching applications

Description

This device is a dual N-channel Power MOSFET developed using STMicroelectronics' STripFET™ F5 technology. The device has been optimized to achieve very low on-state resistance, contributing to a FoM that is among the best in its class.

Table 1: Device summary

Order code	Marking	Package	Packing
STL15DN4F5	15DN4F5	PowerFLAT [™] 5x6 double island	Tape and reel

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	±20	V
I _D ⁽¹⁾	Drain current (continuous) at Tc = 25 °C	60	А
ID ⁽²⁾	Drain current (continuous) at T _{pcb} = 25 °C	15	А
ID ⁽²⁾	Drain current (continuous) at T _{pcb} = 100°C	10	А
I _{DM} ⁽²⁾⁽³⁾	Drain current (pulsed)	60	А
Ртот ⁽¹⁾	Total dissipation at $T_c = 25 \ ^{\circ}C$	60	W
P _{TOT} ⁽²⁾	Total dissipation at $T_{pcb} = 25^{\circ}C$	4.3	W
Tj	Operating junction temperature range	EE to 17E	ŝ
T _{stg}	Storage temperature range	-55 10 175	-U

Notes:

 $^{(1)}\mbox{The}$ value is rated according $R_{\mbox{thj-c.}}$

 $^{(2)}\mbox{The value is rated according $R_{\mbox{thj-pcb}}$}.$

 $^{\rm (3)}{\rm Pulse}$ width limited by safe operating area.

Table 3: Thermal resitance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	2.5	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	35	°C/W

Notes:

 $^{(1)}When$ mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

Table 4: Avalanche data

Symbol	Parameter	Value	Unit
lav	Not-repetitive avalanche current, (pulse width limited by Tj max.)	7.5	Α
Eas ⁽¹⁾	Single pulse avalanche energy (starting $T_J = 25 \text{ °C}$, $I_D = I_{AV}$, $V_{DD} = 24 \text{ V}$)	150	mJ

Notes:

⁽¹⁾Tested at wafer level only.



2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Tvp.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I_D = 250 µA, V_{GS} = 0 V	40	<u> </u>	-	V
Zero gate voltage					1	μA
^{IDSS} d	drain current				10	μA
I _{GSS}	Gate-body leakage current	$V_{\text{GS}} = \pm 20 \text{ V}, V_{\text{DS}} = 0 \text{ V}$			±100	nA
$V_{GS(th)}$	Gate threshold voltage	V_{DS} = V_{GS} , I_{D} = 250 μ A	2		4	V
RDS(on)	Static drain-source on-resistance	V_{GS} = 10 V, I _D = 7.5 A		8	9	mΩ

Notes:

⁽¹⁾Defined by design, not subject to production test

Table 6: Dynamic						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1550	-	
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz,$	-	230	-	nF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V	-	25	-	P
Qg	Total gate charge	$V_{DD} = 20 V, I_D = 15 A,$	-	25	-	
Qgs	Gate-source charge	$V_{GS} = 10 V$	-	6	-	nC
Q _{gd}	Gate-drain charge	gate charge behavior")	-	5.5	-	

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{pp} = 20 V l_p = 7.5 \Delta$	-	18	-	
tr	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	45	-	20
t _{d(off)}	Turn-off delay time	(see Figure 13: "Test circuit for	-	32	-	115
tr	Fall time	resistive load switching times")	-	5	-	



Electrical characteristics

Table 8: Source-drain diode						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Forward on voltage		-		15	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		60	А
Vsd ⁽²⁾	Forward on voltage	$V_{GS} = 0$, $I_{SD} = 15 \text{ A}$	-		1.1	V
trr	Reverse recovery time	I _{SD} = 15 A, di/dt = 100 A/μs	-	30		ns
Qrr	Reverse recovery charge	$V_{DD} = 32 \text{ V}, \text{ T}_{j} = 150 \text{ °C}$	-	35		nC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	2.2		A

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width limited by safe operating area

 $^{(2)}\text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5 %











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Electrical characteristics







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3 Test circuits









4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



4.1 PowerFLAT 5x6 double island WF type C package information



Figure 19: PowerFLAT™ 5x6 double island WF type C package outline



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Package information

Table 9:	Table 9: PowerFLAT™ 5x6 double island WF type C mechanical data			
Dim		mm		
Dini.	Min.	Тур.	Max.	
A	0.80		1.00	
A1	0.02 0.05		0.05	
A2		0.25		
b	0.30		0.50	
С	5.80	6.00	6.10	
D	5.00	5.20	5.40	
D2	4.15		4.45	
D3	4.05	4.20	4.35	
D4	4.80	5.00	5.10	
D5	0.25	0.40	0.55	
D6	0.15	0.30	0.45	
D7	1.68		1.98	
е		1.27		
E	6.20	6.40	6.60	
E2	3.50		3.70	
E3	2.35		2.55	
E4	0.40		0.60	
E5	0.08		0.28	
E6	0.20	0.325	0.45	
E7	0.85	1.00	1.15	
E8	0.55		0.75	
E9	4.00	4.20	4.40	
E10	3.55	3.70	3.85	
L	0.90	1.00	1.10	
L1	0.175	0.275	0.375	
К	1.05		1.35	
θ	0°		12°	



Package information

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4.2 Packing information

Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape





Package information

STL15DN4F5





5 Revision history

Table 10: Document revision history

Date	Revision	Changes
02-Sep-2010	1	First release.
01-Jul-2014	2	Updated: Section 4: Package information. Minor text changes
13-Feb-2015	3	Updated Section 4: Package information. Added Section 5: Packaging information
06-Jul-2016	4	Updated: Section 6.1: "PowerFLAT 5x6 double island WF type C package information". Minor text changes.



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